

## High Temperature Silicon Carbide Power Schottky Diode

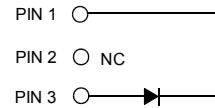
$V_{RRM}$	=	650 V
$I_F (T_c=25^\circ C)$	=	30 A
$Q_c$	=	66 nC

### Features

- 650 V Schottky rectifier
- 250 °C maximum operating temperature
- Electrically isolated base-plate
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of  $V_F$
- Temperature independent switching behavior
- Lowest figure of merit  $Q_c/I_F$
- Available screened to Mil-PRF-19500

### Package

- RoHS Compliant



**TO – 257 (Isolated Base-plate Hermetic Package)**

### Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

### Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- High Temperature DC/DC Converters
- High Temperature Motor and Servo Drives
- High Temperature Inverters
- High Temperature Actuator Control
- Military Power Supplies

### Maximum Ratings at $T_j = 250^\circ C$ , unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	$V_{RRM}$		650	V
Continuous forward current	$I_F$	$T_c = 25^\circ C$	30	A
Continuous forward current	$I_F$	$T_c \leq 225^\circ C$	9.4	A
RMS forward current	$I_{F(RMS)}$	$T_c \leq 225^\circ C$	16	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_c = 25^\circ C, t_p = 10 \text{ ms}$	140	A
Non-repetitive peak forward current	$I_{F,max}$	$T_c = 25^\circ C, t_p = 10 \mu\text{s}$	650	A
$\int I^2 dt$ value	$\int I^2 dt$	$T_c = 25^\circ C, t_p = 10 \text{ ms}$	98	$\text{A}^2\text{s}$
Power dissipation	$P_{tot}$	$T_c = 25^\circ C$	208	W
Operating and storage temperature	$T_j, T_{stg}$		-55 to 250	°C

### Electrical Characteristics at $T_j = 250^\circ C$ , unless otherwise specified

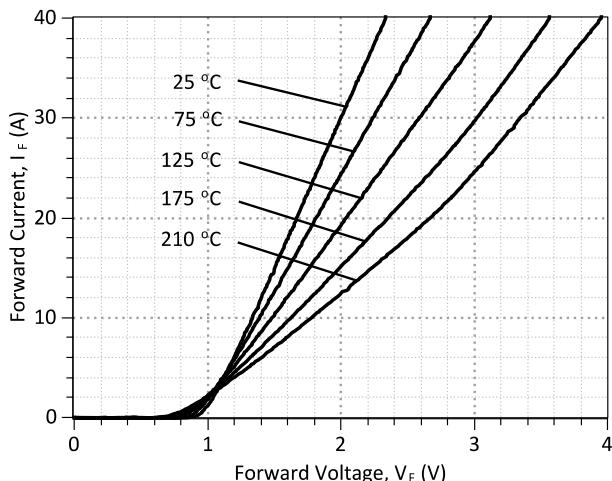
Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	$V_F$	$I_F = 10 \text{ A}, T_j = 25^\circ C$	1.3			V
		$I_F = 10 \text{ A}, T_j = 210^\circ C$	1.8			
Reverse current	$I_R$	$V_R = 650 \text{ V}, T_j = 25^\circ C$	1	5		$\mu\text{A}$
		$V_R = 650 \text{ V}, T_j = 250^\circ C$	50	200		
Total capacitive charge	$Q_c$	$I_F \leq I_{F,MAX}$	66			nC
		$dI_F/dt = 200 \text{ A}/\mu\text{s}$				
Switching time	$t_s$	$T_j = 210^\circ C$	$V_R = 400 \text{ V}$	< 49		ns
			$V_R = 400 \text{ V}$			
Total capacitance	$C$	$V_R = 1 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	1107			pF
		$V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	103			
		$V_R = 650 \text{ V}, f = 1 \text{ MHz}, T_j = 25^\circ C$	99			

### Thermal Characteristics

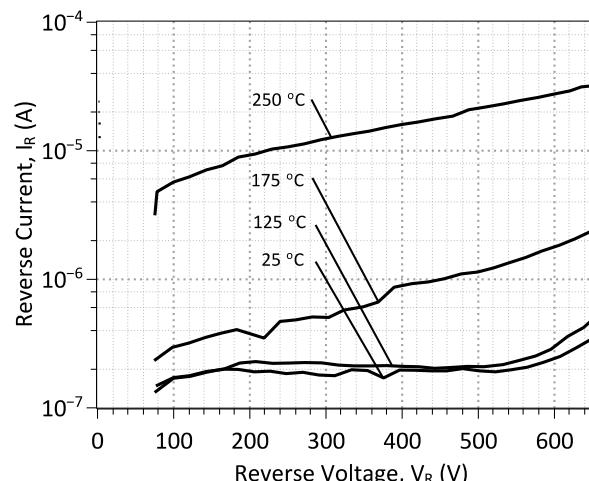
Thermal resistance, junction - case	$R_{thJC}$	1.08	°C/W
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### Mechanical Properties

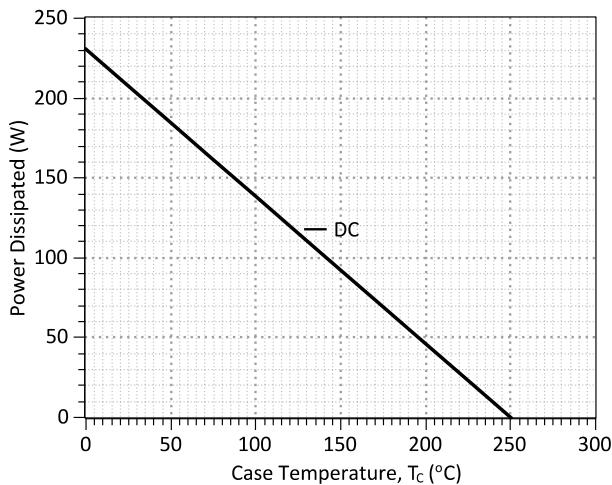
Mounting torque	M	0.6	Nm
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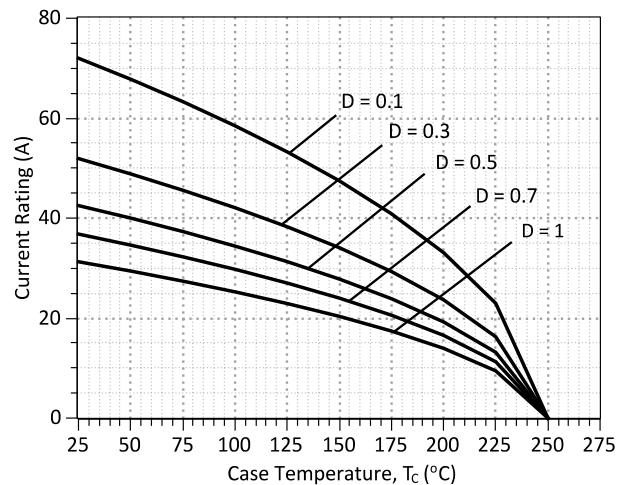
**Figure 1: Typical Forward Characteristics**



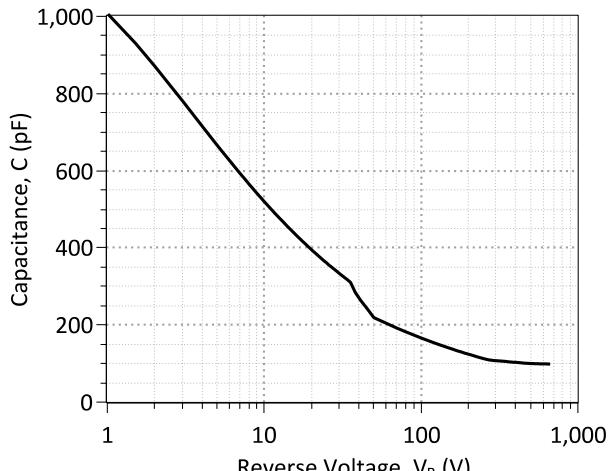
**Figure 2: Typical Reverse Characteristics**



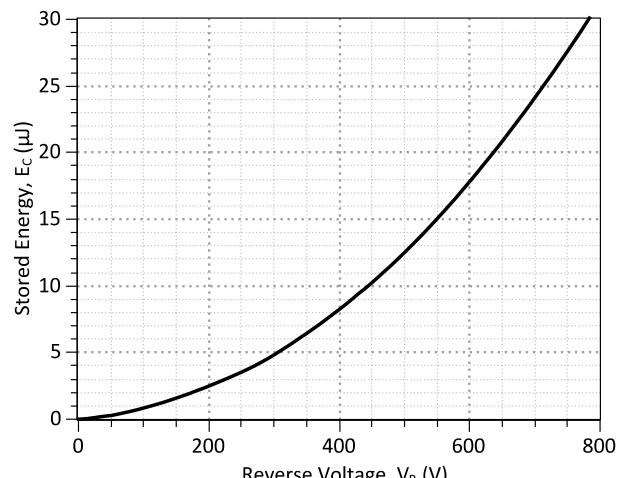
**Figure 3: Power Derating Curve**



**Figure 4: Current Derating Curves (D =  $t_p/T$ ,  $t_p = 400 \mu s$ )  
(Considering worst case  $Z_{th}$  conditions )**



**Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics**



**Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics**

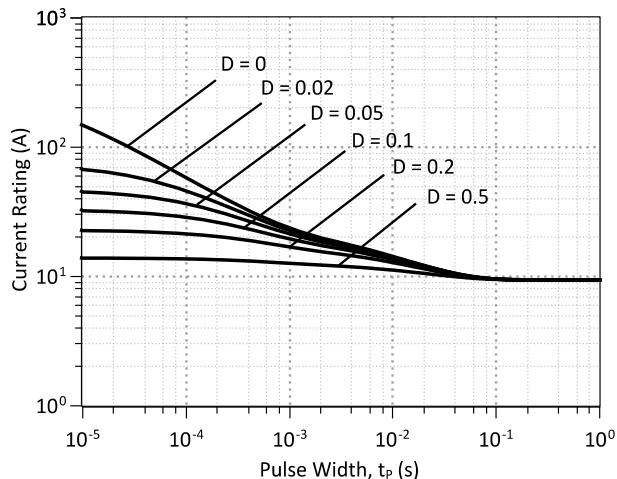


Figure 7: Current vs Pulse Duration Curves at  $T_c = 225\text{ }^\circ\text{C}$

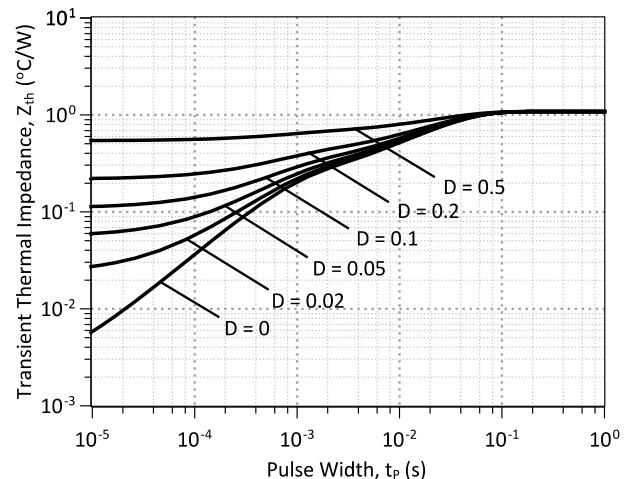
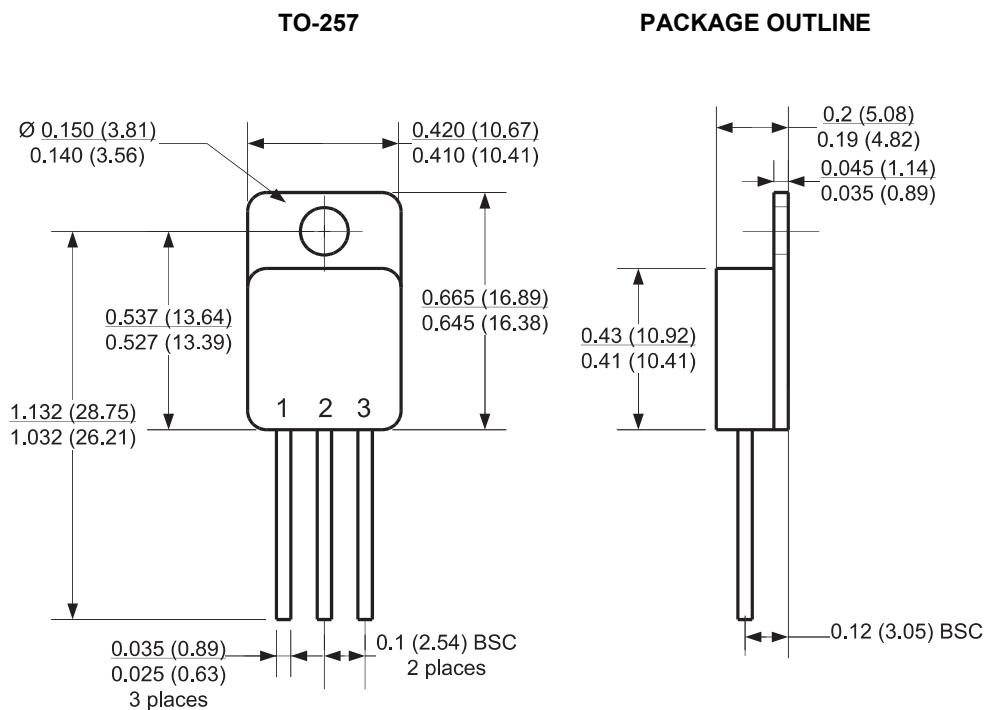


Figure 8: Transient Thermal Impedance

### Package Dimensions:



### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

<b>Revision History</b>			
Date	Revision	Comments	Supersedes
2014/08/26	1	Updated Electrical Characteristics	
2012/04/24	0	Initial release	

## Published by

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## SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 1N8034-GA device.

```

* MODEL OF GeneSiC Semiconductor Inc.
*
* $Revision: 1.0      $
* $Date: 05-SEP-2013      $
*
* GeneSiC Semiconductor Inc.
* 43670 Trade Center Place Ste. 155
* Dulles, VA 20166
* http://www.genesicsemi.com/index.php/hit-sic/schottky
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of 1N8034-GA SPICE Model
*
.SUBCKT 1N8034 ANODE KATHODE
D1 ANODE KATHODE 1N8034_25C; Call the Schottky Diode Model
D2 ANODE KATHODE 1N8034_PIN; Call the PiN Diode Model
.MODEL 1N8034_25C D
+ IS      8.46E-17      RS      0.0319
+ N       1      IKF      1000
+ EG      1.2      XTI      3
+ TRS1    0.0038      TRS2    3.00E-05
+ CJO    1.26E-09      VJ      0.438
+ M      1.5278      FC      0.5
+ TT      1.00E-10      BV      650
+ IBV    1.00E-03      VPK     650
+ IAVE    20      TYPE    Sic_Schottky
+ MFG    GeneSiC_Semiconductor
.MODEL 1N8034_PIN D
+ IS      2.77E-10      RS      0.086693
+ N      3.3505      IKF    3.67E-06
+ EG      3.23      XTI     -10
+ FC      0.5      TT      0
+ BV      650      IBV    1.00E-03
+ VPK    650      IAVE    20
+ TYPE    Sic_Pin
.ENDS
*
* End of 1N8034-GA SPICE Model

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